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## APPLICANTS

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YES

## \*\* CONTINUING DATA \*\*\*\*\*

This application is a CON of PCT/FR02/02341 07/04/2002

PD  
YES

## \*\* FOREIGN APPLICATIONS \*\*\*\*\*

FRANCE 0108859 07/04/2001

## IF REQUIRED, FOREIGN FILING LICENSE GRANTED

\*\* 05/03/2004

| Foreign Priority claimed        | <input checked="" type="checkbox"/> yes <input type="checkbox"/> no                                    | STATE OR<br>COUNTRY | SHEETS  | TOTAL  | INDEPENDENT |
|---------------------------------|--|---------------------|---------|--------|-------------|
| 35 USC 119 (a-d) conditions met | <input checked="" type="checkbox"/> yes <input type="checkbox"/> no <input type="checkbox"/> Met after |                     | DRAWING | CLAIMS | CLAIMS      |
| Verified and Acknowledged       | <i>Hang Chen</i> <i>PD</i><br>Examiner's Signature Initials  | FRANCE              | 1       | 20     | 2           |

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## TITLE

Method for reducing free surface roughness of a semiconductor wafer

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| FILING FEE | FEES: Authority has been given in Paper No. _____ to charge/credit DEPOSIT ACCOUNT | <input type="checkbox"/> All Fees<br><br><input type="checkbox"/> 1.16 Fees ( Filing )<br><br><input type="checkbox"/> 1.17 Fees ( Processing Ext. of time ) |
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